

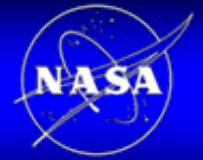


Electron Beam Additive Manufacturing: *State-of-the-Technology, Challenges & Opportunities*



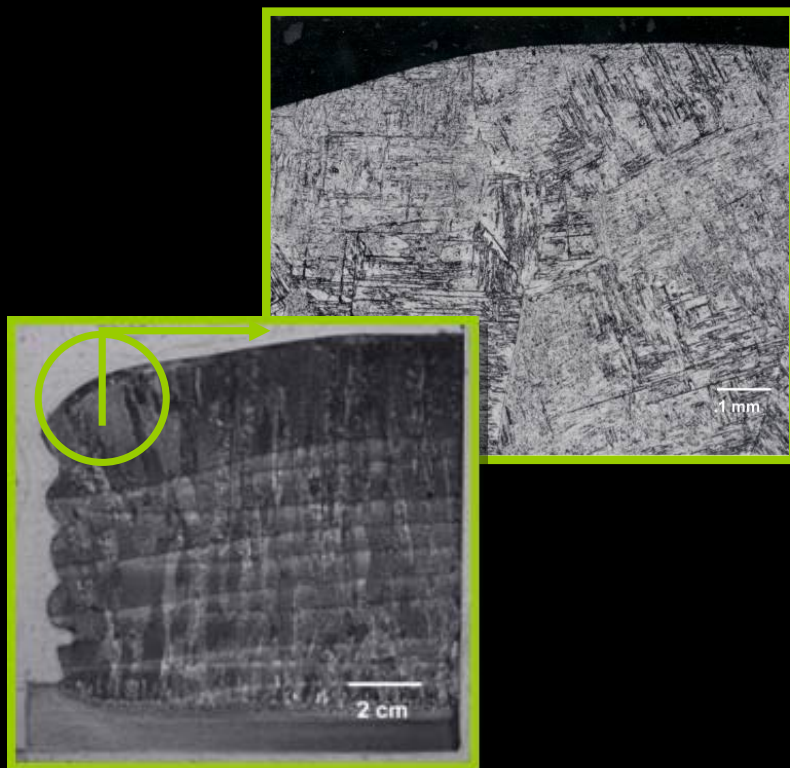
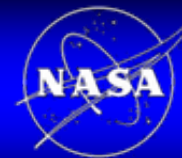
Karen Taminger
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Electron Beam Freeform Fabrication (a.k.a.: EBF³, EBFFF, EBAM)

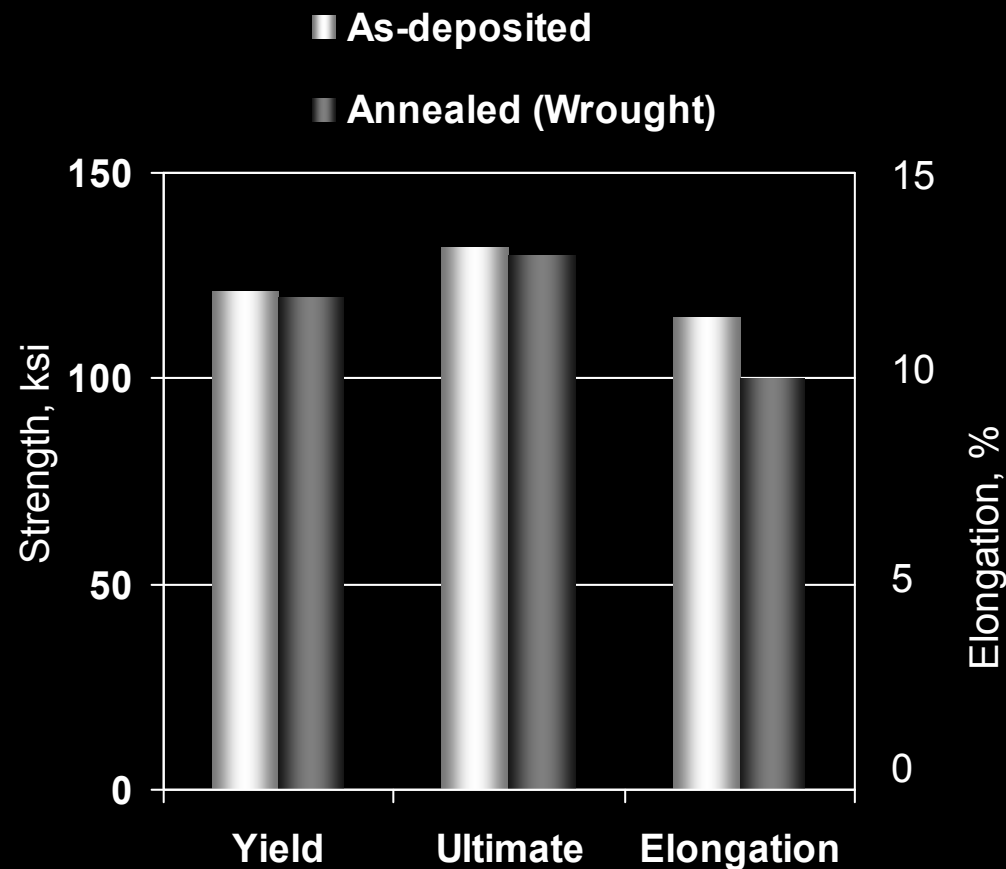


- Electron beam deposition with wire feed
- High deposition rates, large part sizes
- Near-net shape with finished machining

Ti-6Al-4V Processed by EBF³

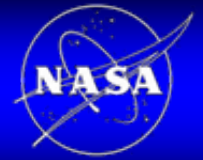


- Large columnar grains grow epitaxially from substrate
- Forms typical alpha-beta lath structure within grains



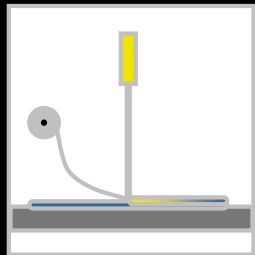
Properties of EBF³ deposited Ti-6-4 equivalent to annealed wrought product

History of EBF³ Development



Technology Inception

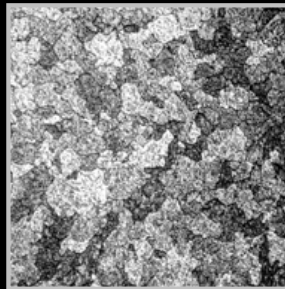
Technology Maturation



EBF³ system installed at NASA LaRC

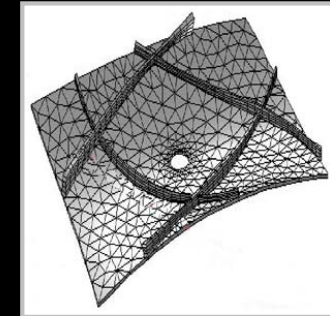
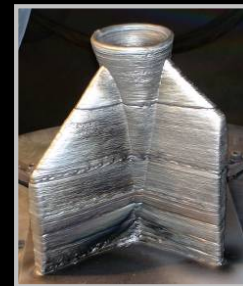


Define EBF³ system specs



EBF³ process understanding

Increasing part complexity



Unitized & graded structures

2001

2002

2003

2004

2005

2006

2007

2003

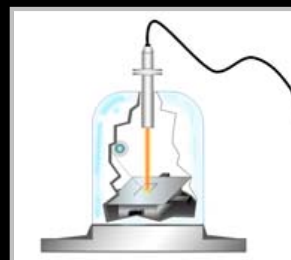
2004

2005

2006

2007

Design portable EBF³ system



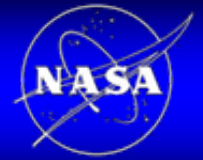
Integrate prototype portable EBF³ system

Microgravity testing

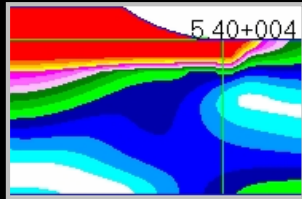


Patent on portable EBF³ concept issued 1/07

Future of EBF³

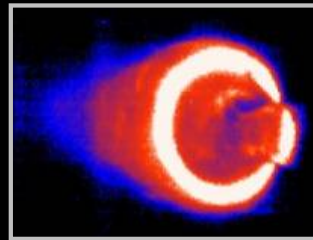


Commercialization



Computationally guided process maturation

Closed loop control



Current Applications



First production parts on aircraft

Influence Future Designs

Selective reinforcement/
integrated sensors



2007

2008

2009

2010

2011

2012

2013 & beyond

Detailed property testing
for certification

Process
certified

2007

2008

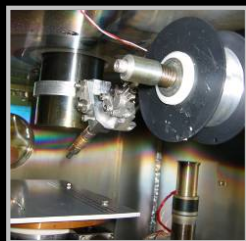
2009

2010

2011

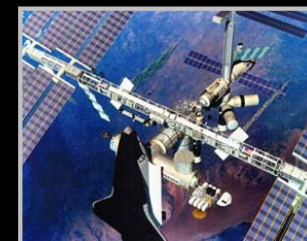
2012

2013 & beyond



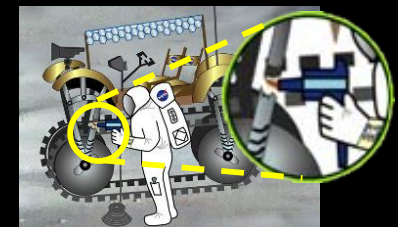
Retire prototype portable system

Next Gen EBF³ lunar
systems build and test

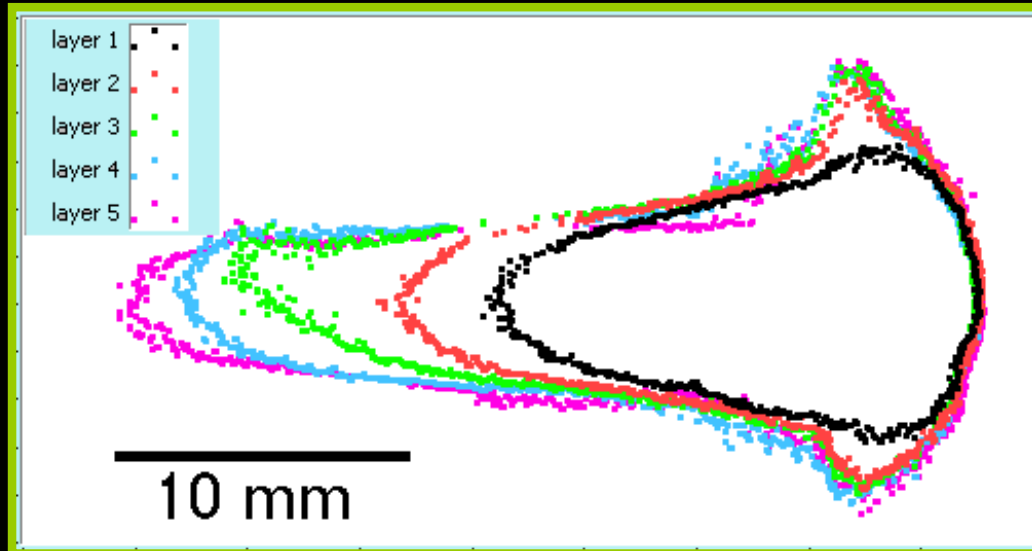
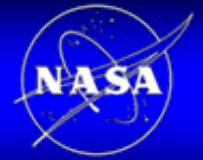


ISS demo of
EBF³ system

Lunar surface
system demo



Need for Process Control



Problem:

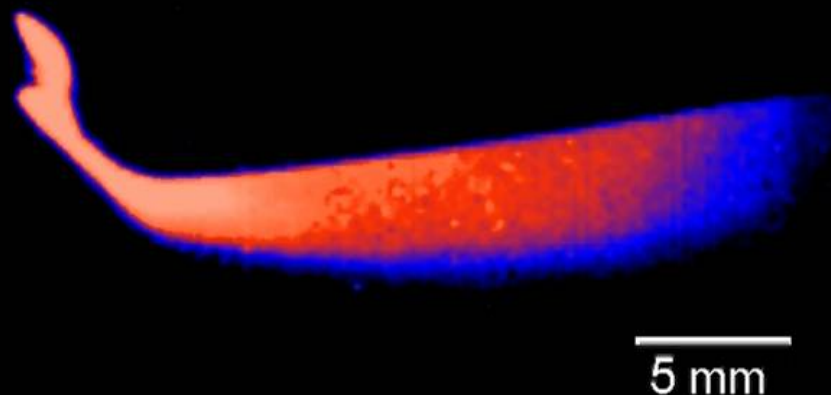
Melt pool changes with temperature from one layer to the next

Current Solution:

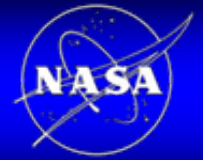
Monitor melt pool size as indication of temperature for process control

Required Work:

- Complete integration of sensors into control system
- Refine control logic to correct for other process anomalies (wire irregularities, change in direction)



Loss of Al in Ti-6Al-4V



Problem:

Al loss in Ti-6-4 due to melting in vacuum (function of temperature & pressure)

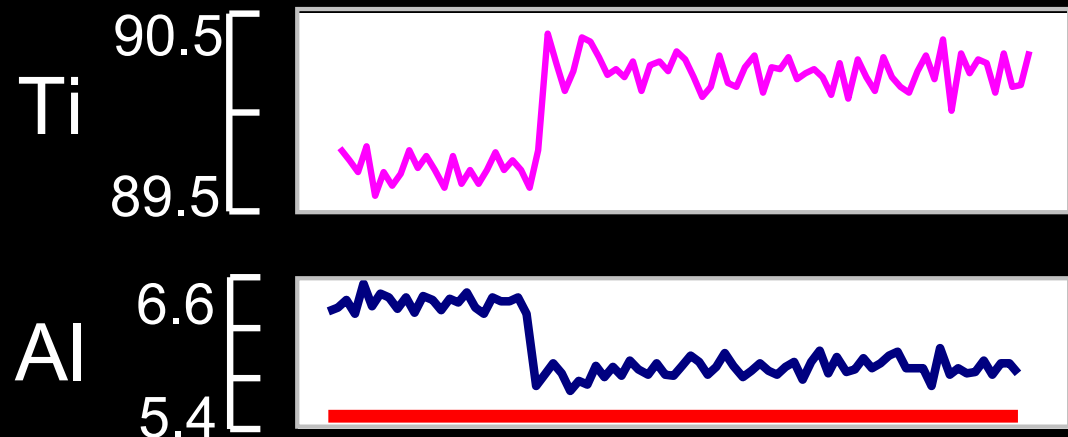
Current Solution:

↑ Al in wire composition

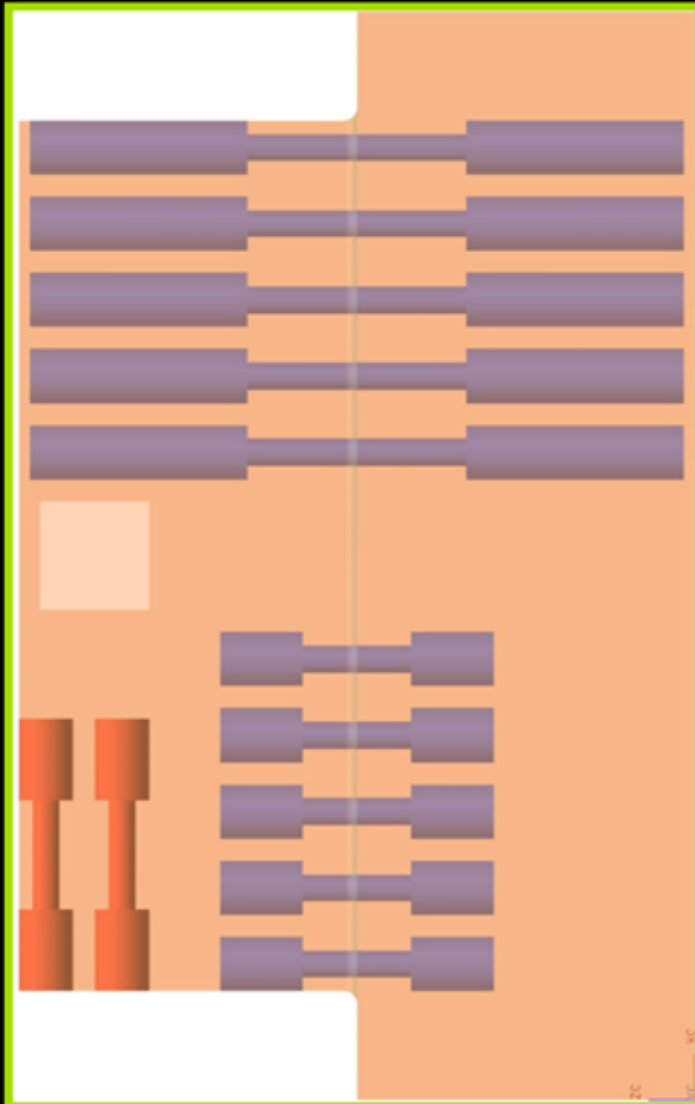
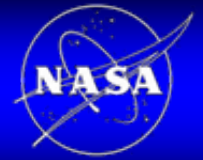
↓ thermal input

Required Work:

- Quantify losses at standard operating parameters to ensure consistency
- Process development to reduce Al loss by reducing thermal input



Certification & Repeatability



Problem:

Part-to-part and machine-to-machine variations limit repeatability

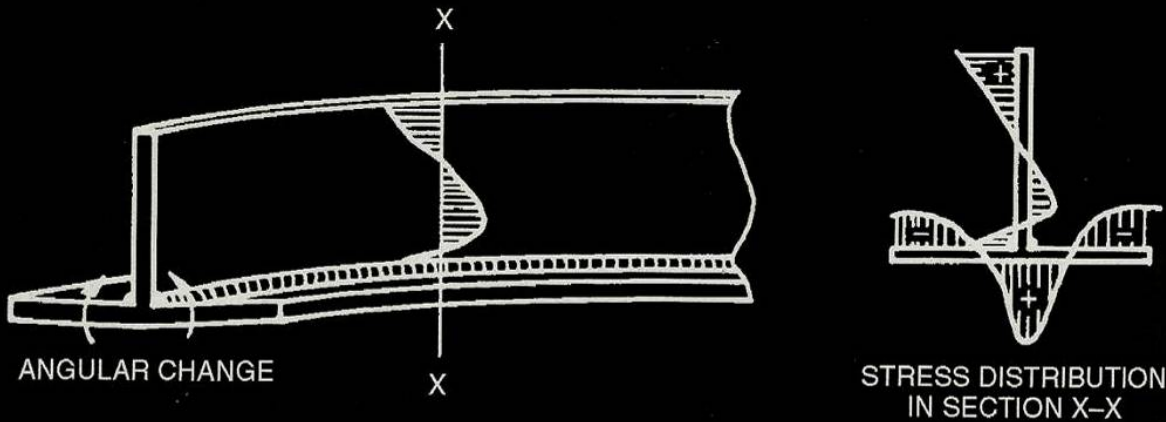
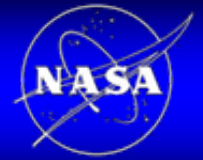
Current Solution:

Define tight process specification & conduct allowables testing

Required Work:

- Compare parts built on different machined with similar build parameters
- Beam probe analysis to monitor beam degradation with filament life
- Generate & maintain database with pedigree data from multiple deposition sites

Distortion and Residual Stress



Problem:

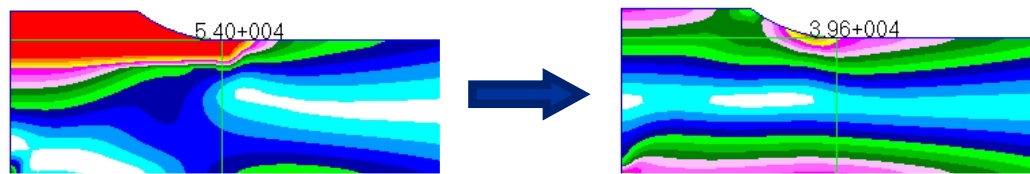
Temperature gradients induce residual stresses & distortion

Current Solution:

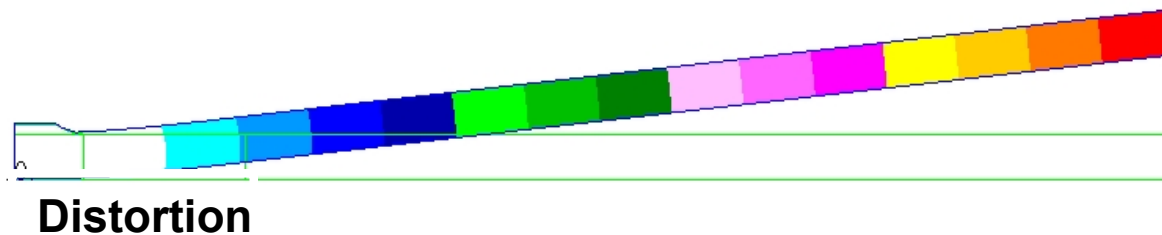
- Balanced deposition on both sides of baseplate
- Frequent thermal stress relief steps

Required Work:

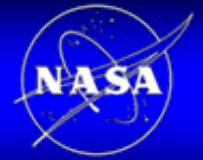
- Post-deposition stress relief
- Modeling & validation of distortion & residual stress
- Process development to reduce distortion in one-sided deposits



Von Mises Stress Before & After Clamp Release



NDE Analysis of EBF³ Parts



Problem:

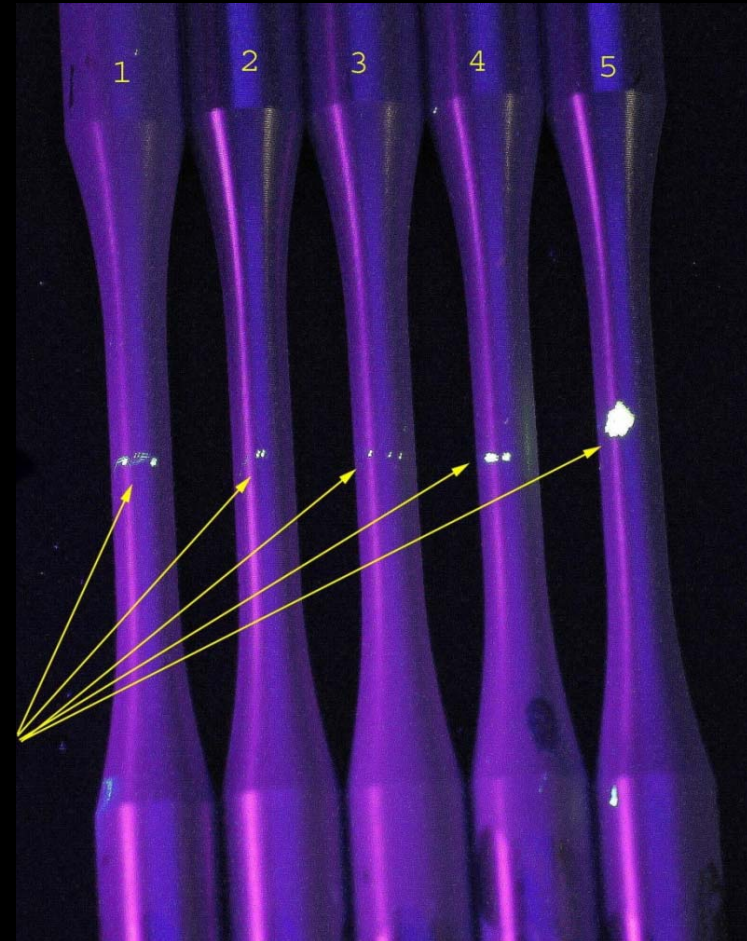
Irregular surface finish of as-deposited EBF³ parts obscures NDE results

Current Solution:

NDE inspection after final machining

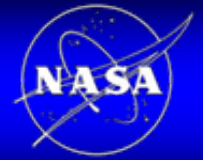
Required Work:

- NDE technique development to detect internal flaws without machining
- Process development to eliminate flaws
- Sensors incorporated into process control system to enable real-time NDE during deposition

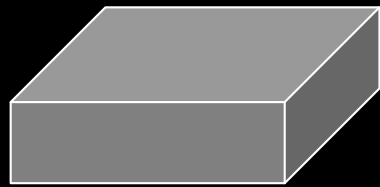


Lack of fusion at substrate/
deposit interface

EBF³ as a Green Manufacturing Process

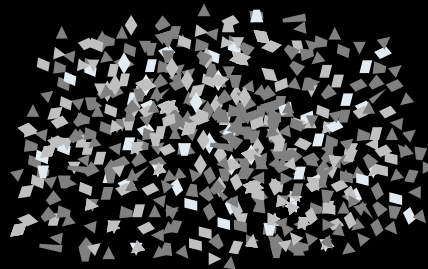


Conventional Machining:



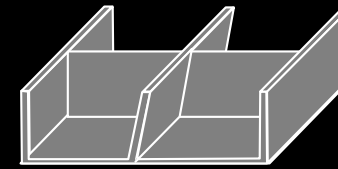
3000 lb.
forged billet

—



2850 lb. chips

=



150 lb. finish
machined part

20 : 1
buy-to-fly

Additive Manufacturing via EBF³:



200 lb.
rolled sheet

+



100 lb.
wire

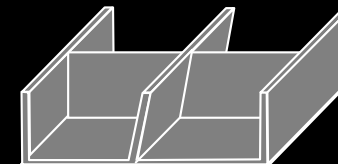
+ EBF³

—



150 lb.
chips

=

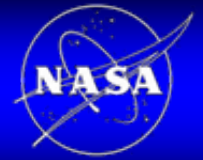


150 lb. finish
machined part

2 : 1
buy-to-fly

EBF³ saves significant resources over current methods:
raw materials, energy, fewer chemicals (cutting fluids), lead time = cost

Repair via EBF³



Opportunity:

Repair capability for large damaged parts that are irreparable by current technologies

- High value components (new or damaged in service)
- Reduce lead time to repair

Required Work:

- Tolerance control (residual stress, distortion)
- Material condition (HAZ, heat treat)
- Repair design (programming, stress analysis)
- Qualification (MRB)

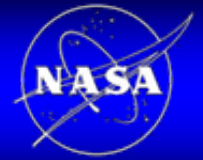
* LM Aero ADP currently has three such parts and seeks funding to develop the

technology

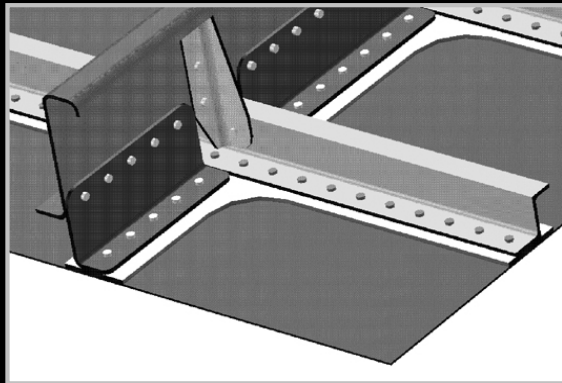
Karen.M.Tamingel@nasa.gov



Novel Structural Designs



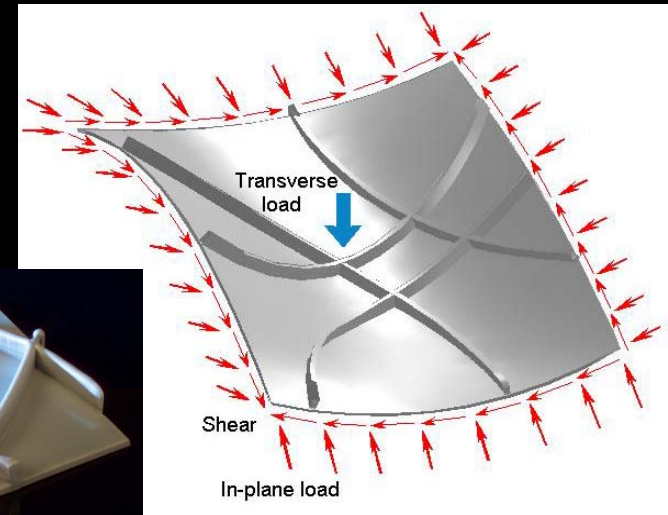
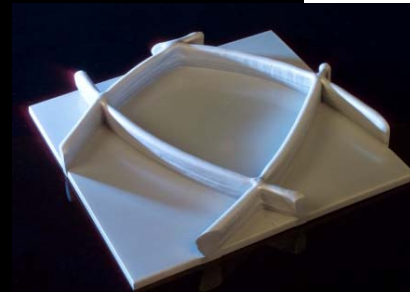
Designed for Assembly



Assembled from many discrete components

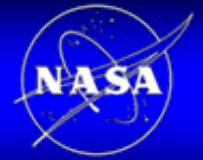


Designed for Performance



- Freeform fabrication of unitized structure allows use of functionally graded, locally controlled features
- New structural design & analysis tools allow concept development of structures with contoured stiffeners that follow load paths
- New manufacturing process coupled with novel structural analysis and design enables performance enhancements and reduced cost, weight

EBF³ Far Term Possibilities



- **Complex geometries not possible with conventional processes**
- **Integrated multi-functional components**
- **Functional gradient materials**
- **Selectively reinforced metals**
- **Controlled microstructures**
- **Integrated sensors**

